2SA2028

Silicon PNP epitaxial planar type

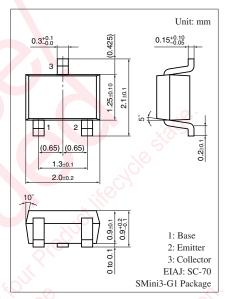
For DC-DC converter

■ Features

- Low collector-emitter saturation voltage V_{CE(sat)}
- High-speed switching
- S-Mini type package, allowing downsizing and thinning of the equipment and automatic insertion through the tape packing

■ Absolute Maximum Ratings $T_a = 25^{\circ}C$

| Parameter | Symbol | Rating | Unit |
|---------------------------------------|------------------|-------------|------|
| Collector-base voltage (Emitter open) | V _{CBO} | -20 | V |
| Collector-emitter voltage (Base open) | V_{CEO} | -20 | V |
| Emitter-base voltage (Collector open) | V _{EBO} | -5 | V |
| Collector current | $I_{\rm C}$ | -1 | A |
| Peak collector current | I_{CP} | -3 | A |
| Collector power dissipation | P _C | 150 | mW |
| Junction temperature | T _j | 150 | °C |
| Storage temperature | T _{stg} | -55 to +125 | °C |



Marking Symbol: AT

■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|---------------------------------------|----------------------|--|-----|-----|------|------|
| Collector-base voltage (Emitter open) | V _{CBO} | $I_{\rm C} = -10 \mu \text{A}, I_{\rm E} = 0$ | -20 | | | V |
| Collector-emitter voltage (Base open) | V _{CEO} | $I_{\rm C} = -1 \text{ mA}, I_{\rm B} = 0$ | -20 | | | V |
| Emitter-base voltage (Collector open) | V _{EBO} | $I_E = -10 \mu\text{A}, I_C = 0$ | -5 | | | V |
| Forward current transfer ratio | h _{FE} | $V_{CE} = -2 \text{ V}, I_{C} = -100 \text{ mA}$ | 160 | | 560 | _ |
| Collector-emitter saturation voltage | V _{CE(sat)} | $I_C = -200 \text{ mA}, I_B = -10 \text{ mA}$ | | -40 | -100 | mV |
| Transition frequency | f_T | $V_{CB} = -10 \text{ V}, I_E = 10 \text{ mA}, f = 200 \text{ MHz}$ | | 170 | | MHz |
| Collector output capacitance | C _{ob} | $V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$ | | 20 | 30 | pF |
| (Common base, input open circuited) | | | | | | |

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

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